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## FAIRCHILD

SEMICONDUCTOR TM

November 1998

### FDG6321C Dual N & P Channel Digital FET

#### **General Description**

These dual N & P-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for bipolar digital transistors and small signal MOSFETS. Since bias resistors are not required, this dual digital FET can replace several different digital transistors, with different bias resistor values.

#### Features

- N-Ch 0.50 A, 25 V,  $R_{\rm DS(ON)} = 0.45 \ \Omega \ @ V_{\rm GS} = 4.5 V.$  $R_{\rm DS(ON)} = 0.60 \ \Omega \ @ V_{\rm GS} = 2.7 \ V.$
- P-Ch -0.41 A, -25 V,  $R_{DS(ON)} = 1.1 \Omega @ V_{GS} = -4.5V.$  $R_{DS(ON)} = 1.5 \Omega @ V_{GS} = -2.7V.$
- Very small package outline SC70-6.
- Very low level gate drive requirements allowing direct operation in 3 V circuits(V<sub>GS(th)</sub> < 1.5 V).</li>
- Gate-Source Zener for ESD ruggedness (>6kV Human Body Model).

415

*						
SC70-	6	SOT-23	SuperSOT <sup>™</sup> -6	SOT-8	SO-8	SOIC-14
	D1	G2 2 <sup>1</sup> 2 <sup>1</sup> 0 0	2			
		num Ratings	$\Gamma_A = 25^{\circ}$ C unless otherwise r			
Symbol	ute Maxim Paramete	num Ratings	$\Gamma_{A} = 25^{\circ}$ C unless otherwise r	noted N-Channel	P-Channel	Units
Symbol	ute Maxim Paramete	0-6 S1 The second secon	$\Gamma_A = 25^{\circ}$ C unless otherwise r	noted		Units
<b>Symbol</b> V <sub>DSS</sub>	ute Maxim Paramete	num Ratings	Γ <sub>A</sub> = 25°C unless otherwise r	noted N-Channel	P-Channel	
Symbol V <sub>DSS</sub> V <sub>GSS</sub>	<b>Paramete</b> Drain-Sour Gate-Sour	num Ratings		noted N-Channel 25	P-Channel -25	V
Symbol V <sub>DSS</sub> V <sub>GSS</sub>	<b>Paramete</b> Drain-Sour Gate-Sour	num Ratings		noted N-Channel 25 8	P-Channel -25 -8	V V
Symbol V <sub>DSS</sub> V <sub>GSS</sub> I <sub>D</sub>	<b>Paramete</b> Drain-Sour Gate-Sour Drain Cur	num Ratings		noted N-Channel 25 8 0.5	P-Channel -25 -8 -0.41	V V
Absolu           Symbol           V <sub>DSS</sub> V <sub>GSS</sub> I <sub>D</sub> P <sub>D</sub> T <sub>J</sub> ,T <sub>STG</sub>	Paramete Drain-Sour Gate-Sour Drain Cur Maximum	num Ratings	(Note 1)	noted N-Channel 25 8 0.5	P-Channel           -25           -8           -0.41           -1.2	V V A

Thermal Resistance, Junction-to-Ambient (Note 1)

 $R_{\theta JA}$ 

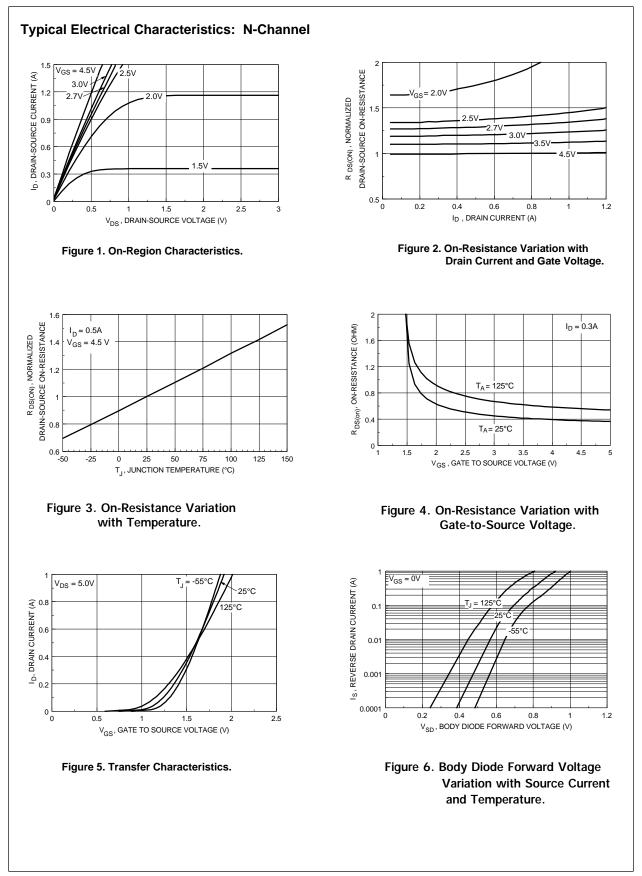
THERMAL CHARACTERISTICS

°C/W

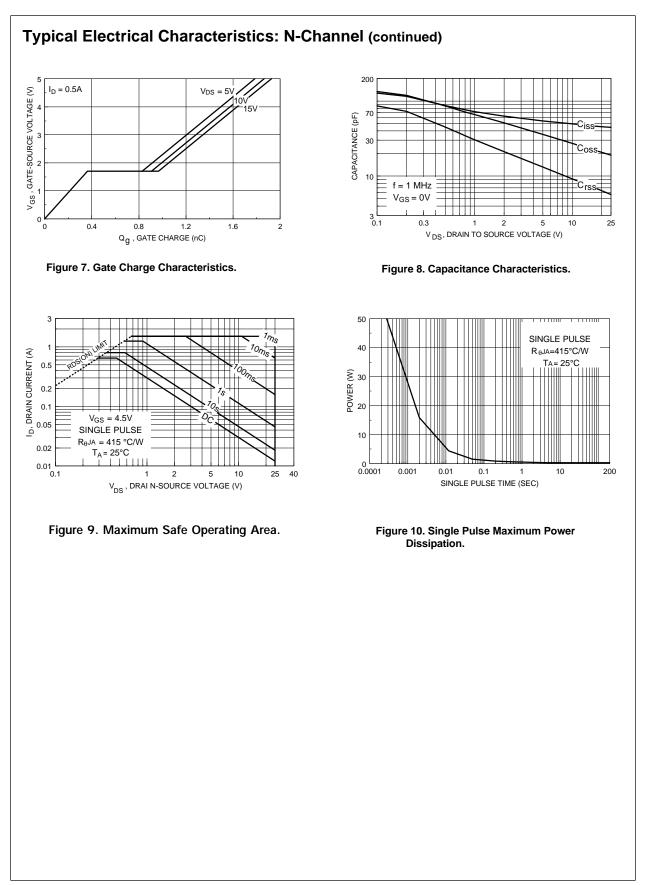
Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS		51			1	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	N-Ch	25			V
000		$V_{gs} = 0 \text{ V}, \text{ I}_{p} = -250 \mu\text{A}$	P-Ch	-25			
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_p = 250 \mu$ A, Referenced to 25 °C	N-Ch		26		mV/°C
Dss J		$I_{\rm p}$ = -250 µA, Referenced to 25 °C	P-Ch		-22		1
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	N-Ch			1 µA	μA
200		T <sub>J</sub> = 55°C				10	
I <sub>GSS</sub>	Gate - Body Leakage Current	$V_{ps} = -20 \text{ V}, \text{ V}_{qs} = 0 \text{ V}$	P-Ch			-1	μA
	, ,	T <sub>1</sub> = 55°C				-10	
I <sub>GSS</sub>	Gate - Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$	N-Ch			100	nA
635	, ,	$V_{gs} = -8 V, V_{Ds} = 0 V$	P-Ch			-100	nA
ON CHARA	CTERISTICS (Note 2)	GS DS					ļ
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	N-Ch	0.65	0.8	1.5	V
GS(III)	5	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \mu {\rm A}$	P-Ch	-0.65	-0.82	-1.5	
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_p = 250 \mu$ A, Referenced to $25 ^{\circ}$ C	N-Ch		-2.6		mV/ °C
GS(th) GS(th)	5 1	$I_p = -250 \ \mu$ A, Referenced to 25 °C	P-Ch		2.1		
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 0.5 \text{ A}$	N-Ch		0.34	0.45	Ω
DS(ON)		T_ =125°C			0.55	0.72	
		$V_{gs} = 2.7 \text{ V}, I_{p} = 0.2 \text{ A}$			0.44	0.6	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -0.41 \text{ A}$	P-Ch		0.85	1.1	
		T <sub>J</sub> =125°C			1.2	1.8	
		$V_{gs} = -2.7 \text{ V}, I_{p} = -0.25 \text{ A}$			1.15	1.5	
D(ON)	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	N-Ch	0.5			Α
D(ON)		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	P-Ch	-0.41			
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	N-Ch		1.45		S
		$V_{\rm DS} = -5 \text{ V}, \text{ I}_{\rm D} = -0.41 \text{ A}$	P-Ch		0.9		
	CHARACTERISTICS		1				1
C <sub>iss</sub>	Input Capacitance	N-Channel	N-Ch		50		pF
100		$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$	P-Ch		62		
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz	N-Ch		28		
		P-Channel	P-Ch		34		
C <sub>rss</sub>	Reverse Transfer Capacitance	$V_{\rm DS} = -10 \text{ V}, V_{\rm GS} = 0 \text{ V},$	N-Ch		9		
		f = 1.0 MHz	P-Ch		10		

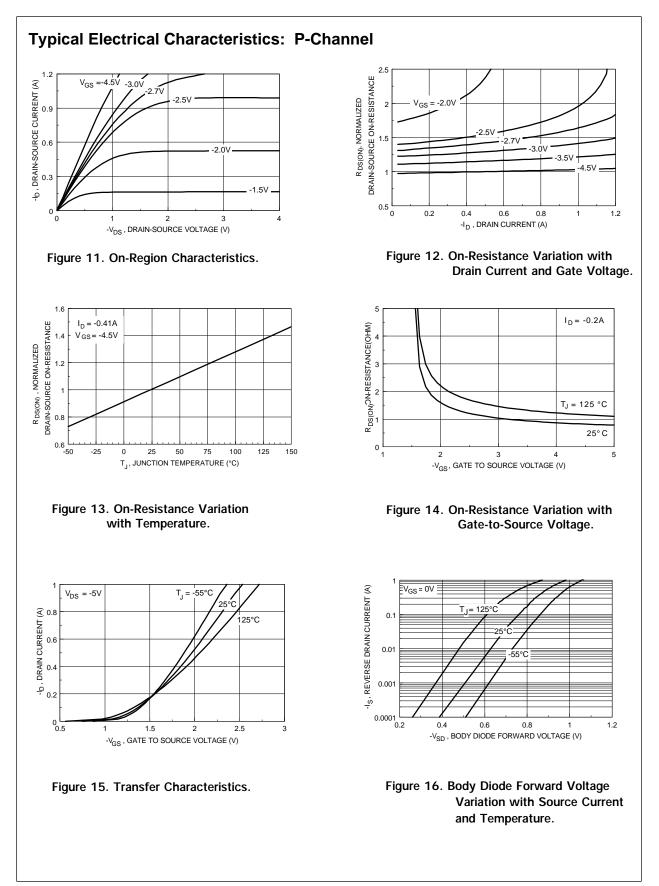
SWITCHI	NG CHARACTERISTICS (Note 2)						
Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units
t <sub>D(on)</sub>	Turn - On Delay Time	N-Channel	N-Ch		3	6	nS
		$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A},$	P-Ch		7	15	
t,	Turn - On Rise Time	$\rm V_{GS}{=}$ 4.5 V, $\rm R_{GEN}{=}$ 50 $\Omega$	N-Ch		8.5	18	nS
			P-Ch		8	16	
t <sub>D(off)</sub>	Turn - Off Delay Time	P-Channel	N-Ch		17	30	nS
		$V_{DD} = -5 \text{ V}, \text{ I}_{D} = -0.5 \text{ A},$	P-Ch		55	80	
t <sub>r</sub>	Turn - Off Fall Time	$V_{GS}$ = -4.5 V, $R_{GEN}$ = 50 $\Omega$	N-Ch		13	25	nS
			P-Ch		35	60	
Q <sub>q</sub>	Total Gate Charge	N-Channel	N-Ch		1.64	2.3	nC
		$V_{\rm DS} = 5 \text{ V}, \text{ I}_{\rm D} = 0.5 \text{ A},$	P-Ch		1.1	1.5	
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 4.5 V$	N-Ch		0.38		nC
		P- Channel	P-Ch		0.31		
$Q_{gd}$	Gate-Drain Charge	$V_{\rm DS} = -5 \ V, \ I_{\rm D} = -0.41 \ A,$	N-Ch		0.45		nC
		V <sub>GS</sub> = -4.5 V	P-Ch		0.29		
DRAIN-SC	OURCE DIODE CHARACTERISTICS AND	MAXIMUM RATINGS					
I <sub>s</sub>	Maximum Continuous Drain-Source Diode Forward Current					0.25	А
			P-Ch			-0.25	
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \ I_{S} = 0.5 \text{ A} \ (\text{Note 2})$	N-Ch		0.8	1.2	V
		$V_{GS} = 0 V, I_{S} = -0.5 A$ (Note 2)	P-Ch		-0.85	-1.2	

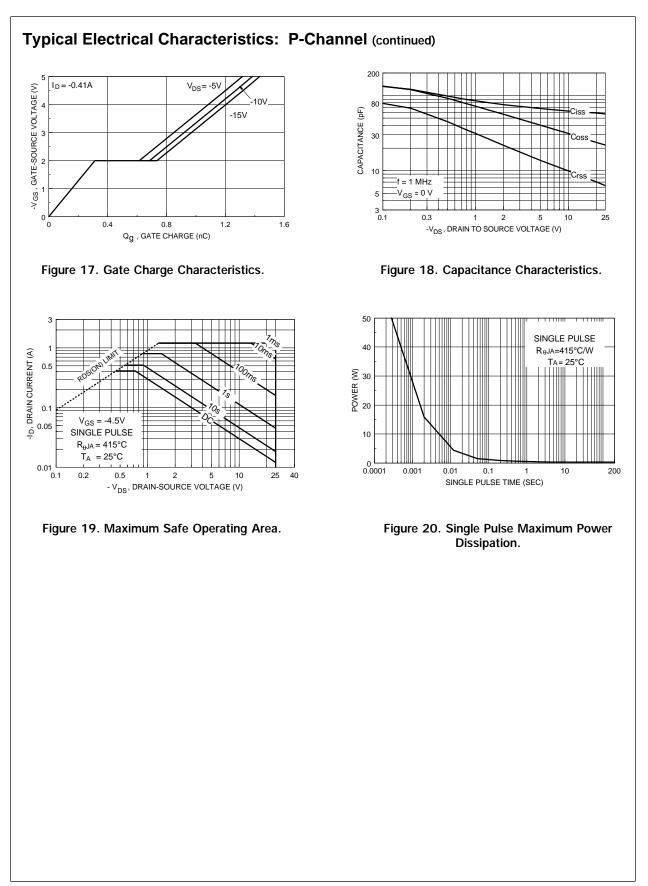
1. R<sub>BM</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>BC</sub> is guaranteed by design while  $R_{ack}$  is determined by the user's board design.  $R_{a_{B,N}} = 415^{\circ}$ C/W on minimum mounting pad on FR-4 board in still air. 2. Pulse Test: Pulse Width  $\leq 300\mu$ s, Duty Cycle  $\leq 2.0\%$ .

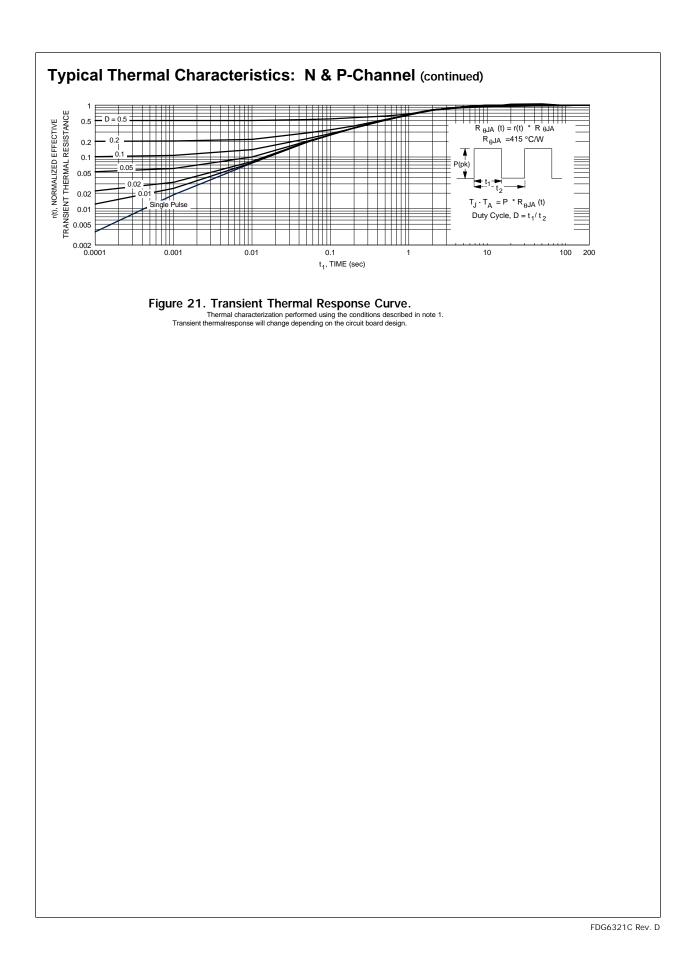


FDG6321C Rev. D









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